MOSFET - Power, Dual **N-Channel** 40 V, 11.5 mΩ, 36 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFD5C470NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage			V_{DSS}	40	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	>
Continuous Drain	Steady	T _C = 25°C	I _D	36	Α
Current R _{θJC} (Notes 1, 2, 3)		T _C = 100°C		25	
Power Dissipation	State	T _C = 25°C	P_{D}	28	W
R _{θJC} (Notes 1, 2)		T _C = 100°C		14	
Continuous Drain		T _A = 25°C	I _D	11	Α
Current R _{θJA} (Notes 1, 2, 3)	Steady State	T _A = 100°C		8.0	
Power Dissipation		T _A = 25°C	P_{D}	3.0	W
R _{θJA} (Notes 1, 2)		T _A = 100°C		1.5	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	110	Α
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	
Source Current (Body Diode)			IS	23	Α
Single Pulse Drain-to-Source Avalanche Energy ($T_J = 25$ °C, $I_{L(pk)} = 2 \text{ A}$)			E _{AS}	49	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		TL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	5.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta,IA}$	49	

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

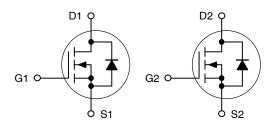


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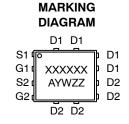
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
40 V	11.5 m Ω @ 10 V	00.4	
	17.8 mΩ @ 4.5 V	36 A	

Dual N-Channel







= Assembly Location Α

= Year W = Work Week

ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

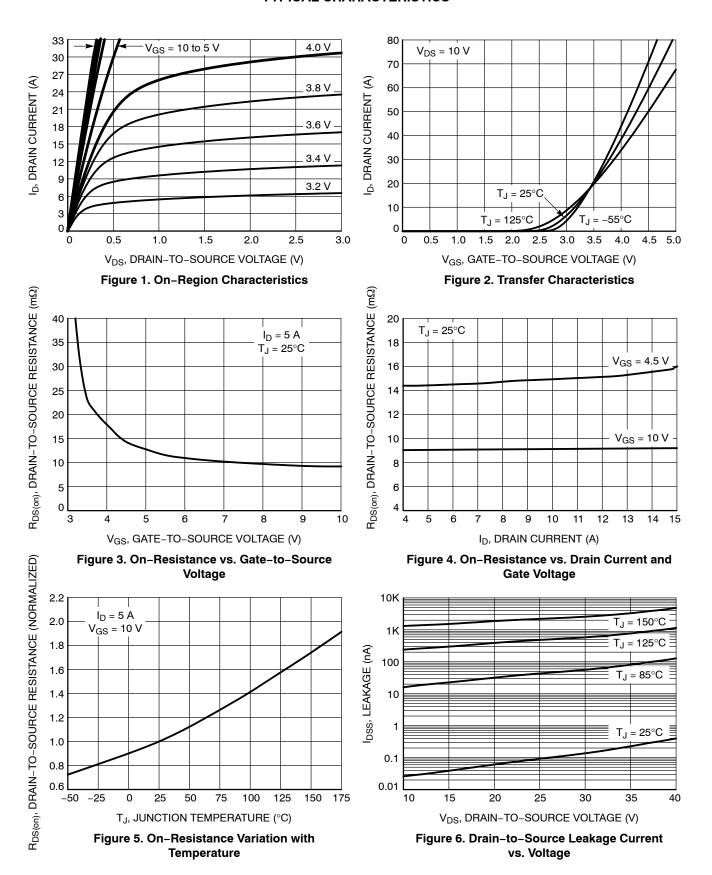
Parameter	Symbol	Test Condi	ition	Min	Тур	Max	Unit	
OFF CHARACTERISTICS					•	•	•	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		40			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				24		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			10		
		V _{DS} = 40 V	T _J = 125°C			100	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	_S = 20 V			100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 20 μA	1.2		2.2	V	
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-4.5		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 5 A		9.2	11.5		
		V _{GS} = 4.5 V	I _D = 5 A		14.6	17.8	mΩ	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _E	₎ = 15 A		30		S	
CHARGES, CAPACITANCES & GATE RESIS	STANCE							
Input Capacitance	C _{ISS}				590			
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			200		pF	
Reverse Transfer Capacitance	C _{RSS}				8.0			
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 32 V; I _D = 15 A			4.0			
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 32 V; I _D = 15 A			9.0			
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 32 V; I _D = 15 A			1.1		nC	
Gate-to-Source Charge	Q _{GS}				2.2			
Gate-to-Drain Charge	Q _{GD}				1.6			
Plateau Voltage	V _{GP}				3.2		V	
SWITCHING CHARACTERISTICS (Note 5)						•	-	
Turn-On Delay Time	t _{d(ON)}				9.3			
Rise Time	t _r	VGS = 4.5 V. VD	ne = 32 V.		55		- ns	
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 4.5 V, V_{D} I_{D} = 15 A, R_{G}	= 1.0 Ω		20			
Fall Time	t _f				36		1	
DRAIN-SOURCE DIODE CHARACTERISTIC	s					•	-	
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V,	T _J = 25°C		0.87	1.2		
		I _S = 15 A	T _J = 125°C		0.76	\ \	V	
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, dIS/dt} = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 15 \text{ A}$			20			
Charge Time	t _a				10		ns	
Discharge Time	t _b				10			
Reverse Recovery Charge	Q _{RR}				9		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

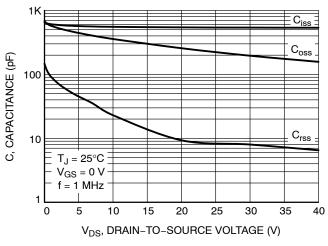


Figure 7. Capacitance Variation

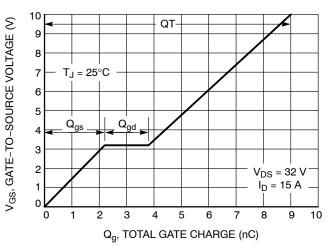


Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

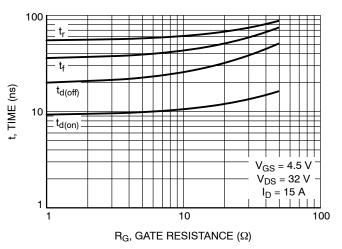


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

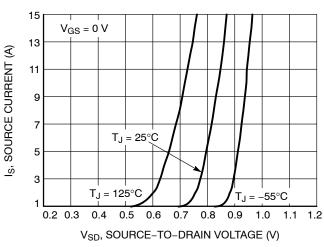


Figure 10. Diode Forward Voltage vs. Current

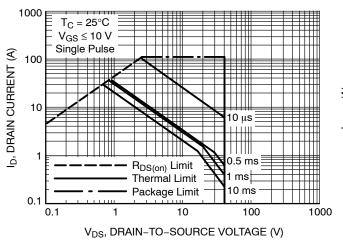


Figure 11. Maximum Rated Forward Biased Safe Operating Area

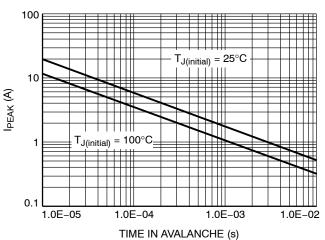


Figure 12. Maximum Drain Current vs. Time in Avalanche

TYPICAL CHARACTERISTICS

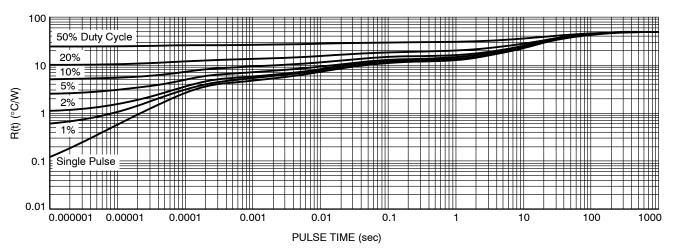


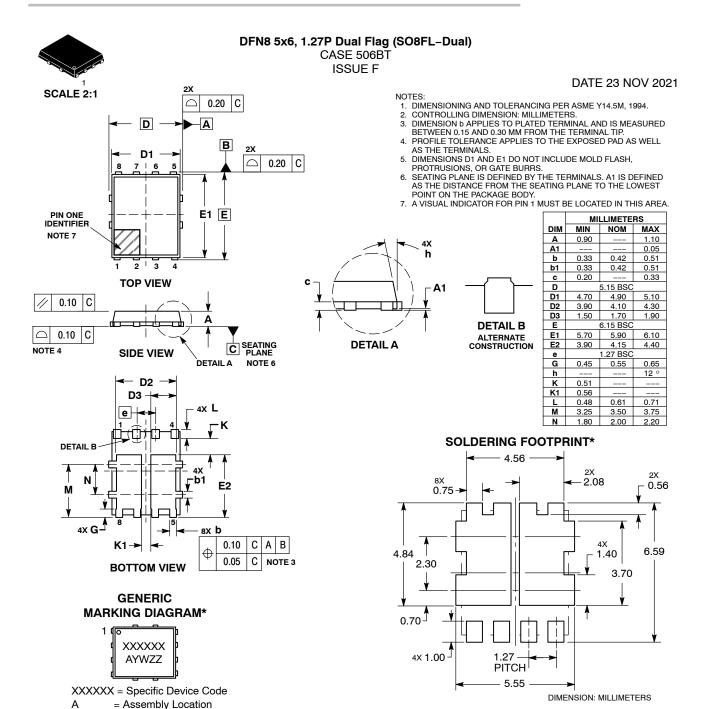
Figure 13. Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFD5C470NLT1G	5C470L	DFN8 (Pb-Free)	1500 / Tape & Reel
NVMFD5C470NLWFT1G	470LWF	DFN8 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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DESCRIPTION:	DFN8 5X6, 1.27P DUAL FLAG (SO8FL-DUAL)		PAGE 1 OF 1		

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= Year

not follow the Generic Marking.

= Work Week

= Lot Traceability *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may

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*For additional information on our Pb-Free strategy and soldering

Mounting Techniques Reference Manual, SOLDERRM/D.

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